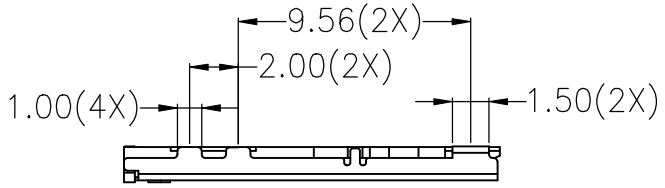
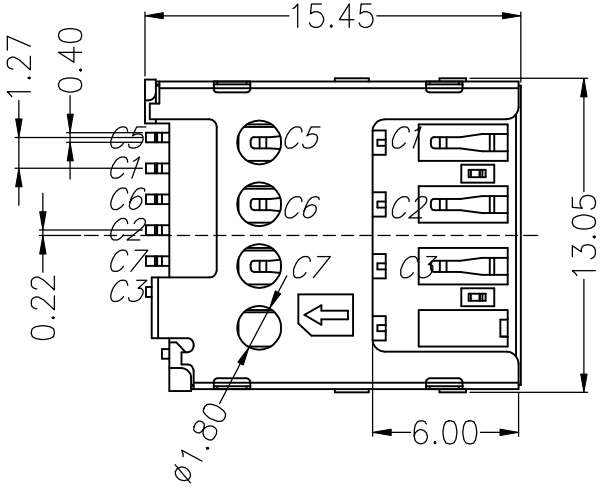
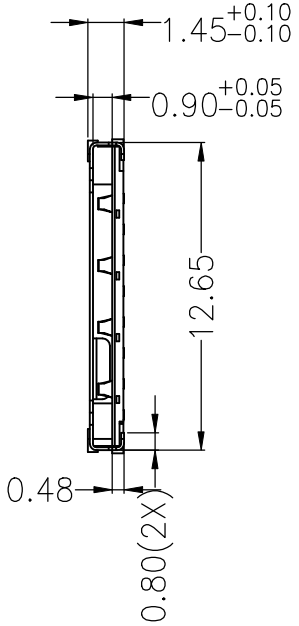
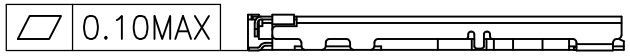
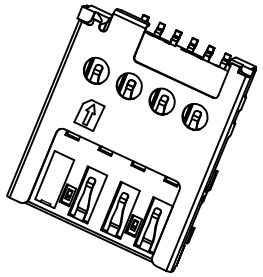
* All Raw Material, Manufacturing, Plating process comply with ROHS

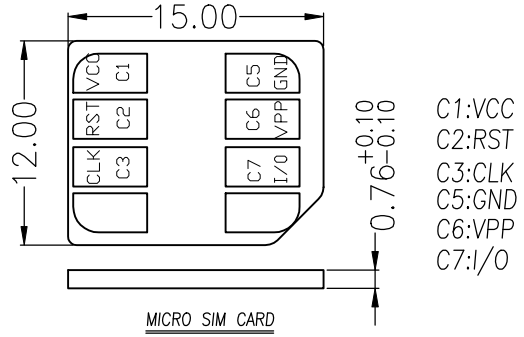






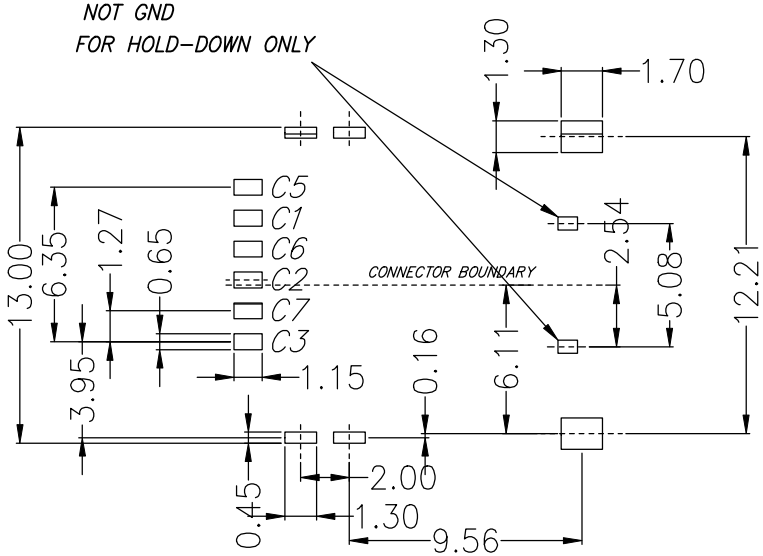






MICRO SIM CARD

NOT GND
FOR HOLD-DOWN ONLY



PCB 焊盘区

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

Specification

MATERIAL:

Insulator: LCP High Temperature Thermoplastic,UL 94V-0.
Contact: C5210
SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overa Contact Au 1u,Pad Au 1u
Shell: Plated 50u'' Ni Overall,Pad Au 1u

Electrical:

Current Rating :0.5Amps max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-40° C~+85° C
Storage Temperature Range :-40° C~+85° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩmax.
Insulation Resistance:1000MΩmin./500VDC
Mating Cycles:10000 Insertions
Reflow peak temp.: 260° C ±5° C, 3~5 S

广东国连电子有限公司
GUANGDONG GUOLIAN ELECTRONICS CO.,LTD

REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.20
X.XX: ±	0.15
X.XXX: ±	0.08
ANGULAR: ±	1°

PRODUCT NAME : MICRO-SIM CONNECTOR 1.46MM HELGHT PUSH PULL	DRAWING: CATCONN	DATE: 2015/04/10	
PRODUCT NO. : MIB5FW1062C2	CHECK: YEMENG	DATE: 2015/04/11	
DRAWING NO. : C-MIB5FW1062C2	APPROVED: WANGHAI	DATE: 2015/04/11	
	SCALE: 1:1	DWG ID: C D	REV.: A / PAGE: 1 OF 1

品名	包装作業規范
料號	C-MIB5FW1062C2

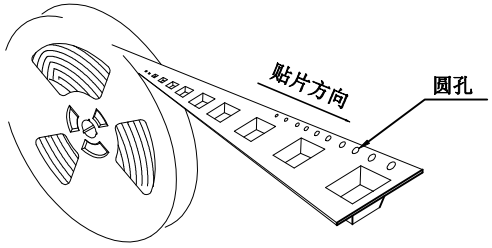
包 裝 作 業 規 範

REEL(料盤)	509-00004
TYPE(卷盤)下帶	508-00017
TYPE(卷盤)上帶	512-00009
紙箱料號	501-00009

包裝作業圖示及說明 (PACKING OPERATION DIAGRAM & INSTRUCTION)

一.

1) 將成品一一放入包裝盤內,依同一方向放入.
2) 包裝時,如圖所示.
3) 一個包裝盤放置1500個成品.

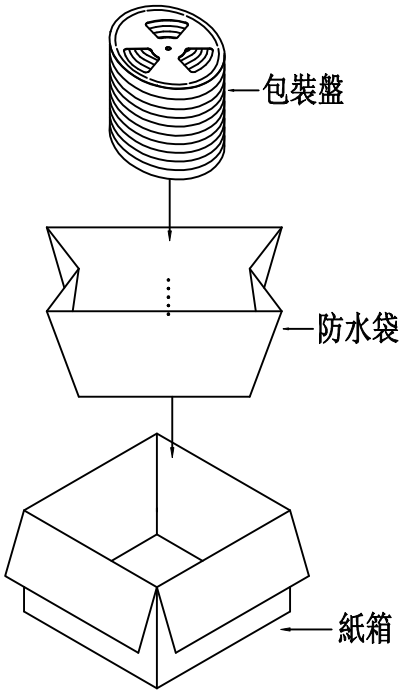


技術要求:

1. 圓孔十个孔距离累计允许公差为±0.20mm.
2. 带长250mm内容许弯曲度1mm.
3. A_0/B_0尺寸由槽底0.30mm高处定义之.
4. K_0尺寸由槽底内表面处至成型上表面处定义之.
5. 所有尺寸定义依循EIA-481-C系准则定义之.
6. 材料:透明PET材质.
7. 材料厚度:0.40±0.05MM.
8. 13"单卷可装长度:30.6Meter(306模).
9. 13"单卷可装顆料:1520psc(前后共空20格).
10. 未注明拔模斜度为5°.
11. 重点检验尺寸代号:W、P_0、P、P_2、E、F、T、A_0、B_0、K_0.
12. 上盖带:自粘21.3*200M/R

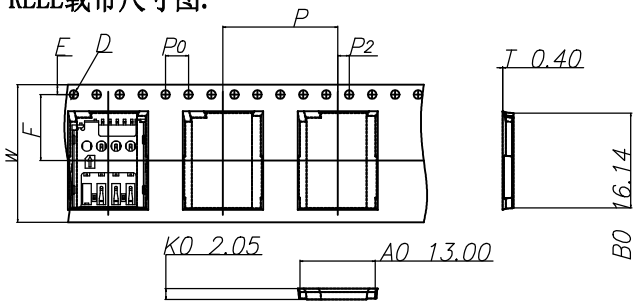
二.

1) 一只紙箱可放置5個包裝盤.
2) 一只紙箱可放7500PCS的成品/或15000PCS成品.
3) 將成品放入包裝盤內包裝完後再裝箱.



三.

1) RELL载带尺寸图.



W	24.00 +0.30 −0.30	P	20.00 +0.10 −0.10	A_0	13.00 +0.10 −0.10	B_0	16.14 +0.10 −0.10
S	+0.10 −0.10	P_0	4.00 +0.10 −0.10	A_1	+0.10 −0.10	B_1	+0.10 −0.10
E	1.75 +0.10 −0.10	P_2	2.00 +0.10 −0.10	A_2	+0.10 −0.10	B_2	+0.10 −0.10
F	11.50 +0.10 −0.10	D_0	Ø1.50 +0.10 −0.00	K_0	2.05 +0.10 −0.10		
T	0.40 +0.05 −0.05	D_1	+0.10 −0.10	K_1	+0.10 −0.10		

产品单重:0.3 g

每盘单重:600 g

每箱单重:3000 g(1500 PCS)

*纸箱规格1:350*350*315(15000 PCS每箱)*

*纸箱规格2:350*350*155(7500 PCS每箱)*

GENERL TOLERANCE		FILE.NO.	3YF.08.0135A	PART.NO.	78646	DRAWN	COCO	MATERIAL		SCALE	1:1
x. ±0.35	x. °±5°	REV.	A	TITLE	MICRO SIM 1.45拉式包裝图-作業規范	CHECKED	YEMENG	DATE	2013-08-10	UNIT	mm
.x ±0.25	.x °±2°	SIZE		SHEET	1 OF 1	APPROVED	WANGHAI	广东国连电子有限公司 GUANGDONG GUOLIAN ELECTRONICS CO.,LTD			
.xx±0.15	.xx ±1°	A4									